

# Data and signal line chokes

Common-mode chokes, ring core 2.2 ... 47 mH, 100 mA, 60 °C

Series/Type: B82791G15/H15

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## Data and signal line chokes

#### Common-mode chokes, ring core

Rated voltage 42 V AC/80 V DC Rated inductance 2.2 mH to 47 mH Rated current 100 mA

#### Construction

- Current-compensated ring core double choke
- Ferrite core
- Polycarbonate case (UL 94 V-0)

#### **Features**

- Without potting
- Vertical or horizontal version
- Suitable for wave soldering
- RoHS-compatible

#### **Application**

Suppression of asymmetrical interference coupled in on data lines, already effective at 10 kHz, e.g. in:

- Telephone lines (analog, ISDN)
- Interfaces with symmetrical data transmission
- Building services automation (EIB bus)
- Automation engineering

#### **Terminals**

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Lead spacing  $12.7 \times 7.4$  (mm) or  $10 \times 15$  (mm)

#### Marking

Manufacturer, ordering code, rated inductance, rated current, graphic symbol (for B82791G15), date of manufacture (MMYY)

#### **Delivery mode**

Cardboard box



B82791G15



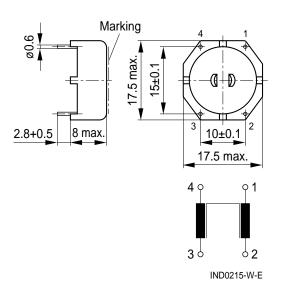
B82791H15

# Data and signal line chokes

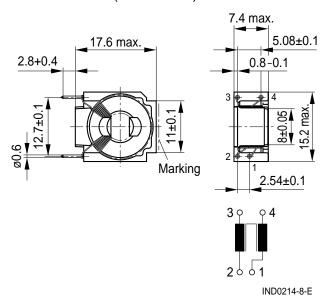
### Common-mode chokes, ring core

### Dimensional drawings and pin configurations

Horizontal version (B82791G15)



Vertical version (B82791H15)



Tolerances to ISO 2768-M unless otherwise noted.

Dimensions in mm

### Technical data and measuring conditions

Rated voltage V <sub>R</sub>	42 V AC (50/60 Hz) / 80 V DC		
Rated temperature T <sub>R</sub>	60 °C		
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature		
Rated inductance L <sub>R</sub>	Measured with Agilent 4284A at 10 kHz, 0.1 mA, 20 °C Inductance is specified per winding.		
Inductance tolerance	±30% at 20 °C B82791H0015A016: –25/+35% at 20 °C		
Inductance decrease ΔL/L <sub>0</sub>	< 10% at DC magnetic bias with I <sub>R</sub> , 20 °C		
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4275A at 10 kHz, 5 mA, 20 °C, typical values		
DC resistance R <sub>typ</sub>	Measured at 20 °C, typical values, specified per winding		
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: $(245 \pm 5)$ °C, $(3 \pm 0.3)$ s Wetting of soldering area $\geq 95\%$ (to IEC 60068-2-20, test Ta)		
Resistance to soldering heat (wave soldering)	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)		
Climatic category	40/125/56 (to IEC 60068-1)		
Storage conditions (packaged)	–25 °C +40 °C, ≤75% RH		
Weight	Approx. 3 g		



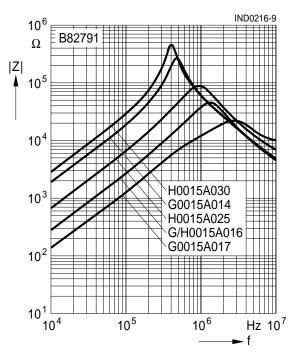
## Common-mode chokes, ring core

### Characteristics and ordering codes

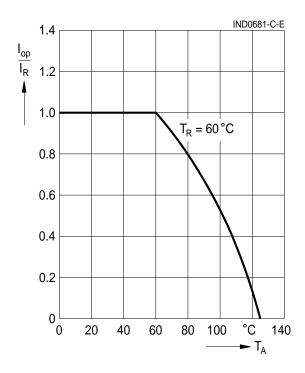
$L_R$	L <sub>stray,typ</sub>	I <sub>R</sub>	R <sub>typ</sub>	V <sub>test</sub>	Ordering code	
mΗ	nH	mA	mΩ	V DC, 2 s	horizontal version	vertical version
2.2	500	100	300	1200	B82791G0015A017	_
4.7	900	100	850	1200	B82791G0015A016	B82791H0015A016
10	1200	100	1200	1200	_	B82791H0015A025
38	3300	100	5000	750	B82791G0015A014	_
47	2100	100	5100	750		B82791H0015A030

# Impedance |Z| versus frequency f

measured with windings in parallel at 20 °C, typical values



# Current derating I<sub>op</sub>/I<sub>R</sub> versus ambient temperature





#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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